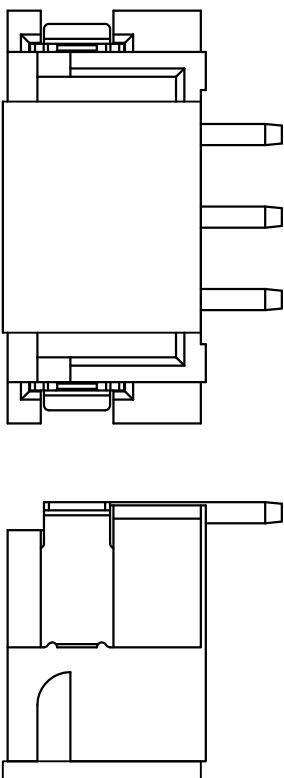
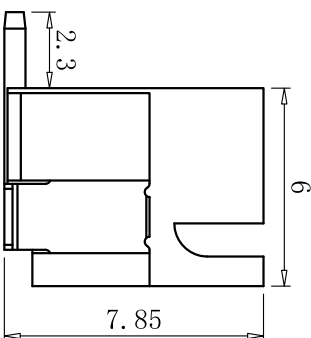
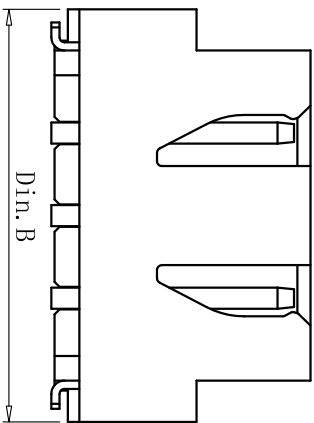
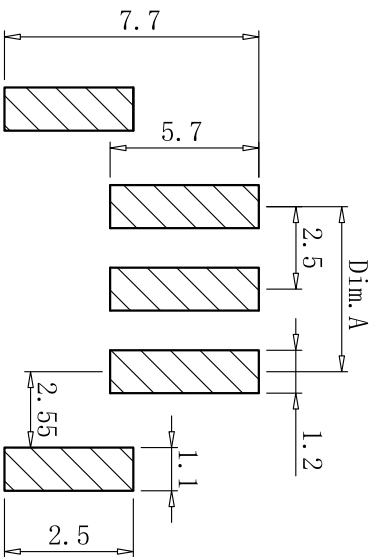
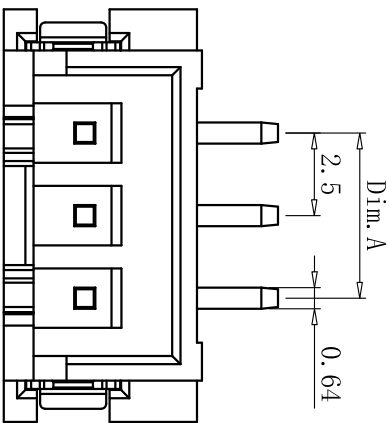
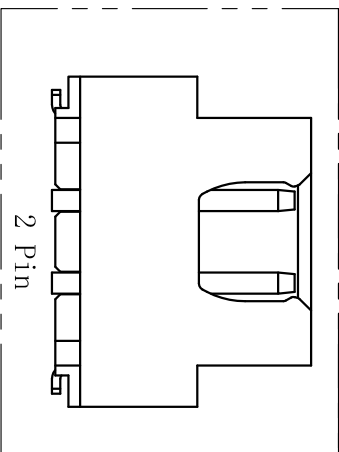


REV.		ECN NO.		DR	DATE
A1		NEW		DR. W	24.10.12



组装吸盖后图示



PCB LAYOUT

- 技术参数 SPECIFICATIONS:
- ◆ 材质: LCP UL94V-0+铜合金
 - ◆ Material: LCP UL94V-0+Copper alloy
 - ◆ 镀层: 锡
 - ◆ Plating: Tin
 - ◆ 颜色: 按订单要求
 - ◆ Colour: As per order requirements

16	37.5	45.0
15	35.0	42.5
14	32.5	40.0
13	30.0	37.5
12	27.5	35.0
11	25.0	32.5
10	22.5	30.0
9	20.0	27.5
8	17.5	25.0
7	15.0	22.5
6	12.5	20.0
5	10.0	17.5
4	7.5	15.0
3	5.0	12.5
2	/	10.0
Circuits		Din. A Din. B

未注公差 TOLERANCE		FIRST ANGLE PROJECTION		浙江成明电子科技有限公司 ZHEJIANG CHENGMING ELECTRONIC TECHNOLOGY CO.,LTD			
>50: ±0.65		拟制 DRAWING BY Ms Wang 24-10-12		型号 PART NO:		TJC3-XH-nALTCM	
>20~50: ±0.5		确认 CHECKED BY Mr Xu 24-10-12		规格 SPECS:			
>5~20: ±0.3		审核 APPROVED BY Mr Lu 24-10-12					
>0~5: ±0.2							
SIZE	A4	UNIT	mm	SCALE	1:1	SHEET	1 OF 1
						REV.	A1